## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7505432

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
SHINSUKE KANDA	08/18/2022

#### **RECEIVING PARTY DATA**

Name:	TADANO LTD.
Street Address:	KO-34, SHINDENCHO, TAKAMATSU-SHI
City:	KAGAWA
State/Country:	JAPAN
Postal Code:	761-0185

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17802412

#### **CORRESPONDENCE DATA**

Fax Number: (703)935-8473

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

5713137556 Phone: Email: mail@paratus.law

**Correspondent Name:** PARATUS LAW GROUP, PLLC

Address Line 1: 1765 GREENSBORO STATION PLACE

Address Line 2: **SUITE 320** 

Address Line 4: TYSONS CORNER, VIRGINIA 22102

ATTORNEY DOCKET NUMBER:	13-410-0122
NAME OF SUBMITTER:	MIHARU SCULLY
SIGNATURE:	/Miharu Scully/
DATE SIGNED:	08/25/2022
	This document serves as an Oath/Declaration (37 CFR 1.63).

**Total Attachments: 1** 

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**PATENT** REEL: 060902 FRAME: 0691 507458540

# DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

As the below named inventor, I hereby declare that:  This declaration is directed to:  White d States application or PCT international application number PCT/FP2021/008989  filed on March 8, 2021  The above-identified application was made or authorized to be made by me.  I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.  WHIRRAS, TADANO LTD.  while offices at Ko-34, Shindencho, Takamatsu-shi, Kagawa 761-0185, JAPAN (hereinafter referred to as ASSIGNEE), is desirous of acquiring all interest in, to and under said lavention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all frequire occurries;  NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged. I by these presents do bereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and in any and all pricingly registerable successors, assigns, and in any and all pricingly registerable successors, assigns, and in any and all pricingly registerable successors, assigns, and in any and all pricingly registerables, and continuations thereof, and in any and all pricingly rights and/or convenion injents under the Internation, and damp to prevent, which may be granted for registerable control, which may be granted for all pricingly and any and all pricingly rights and/or convenion injents under the International Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America affares, and to any other herefits according or to account to near the control of the United States of America affares, and to any other herefits according or to account on the control of the United States and countries foreign thereto, and I hereby authorize mid request the Commissioner of Patents to iss	Title of Invention	CONTROL DEVICE, TERMINAL AND CALCULATION METHOD	
The altached application, or PCT international application number PCT/JP2021/008989  filed on March 8, 2021  The above-identified application was made or authorized to be made by me.  I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.  WHEREAS, TADANO LTD.  Whith are hereas the tentors in the United States and in any and all fereign countries.  NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these processed to be breedy assign, and larguar presentatives, the entire right, title and interest in said invention, asid application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States of America and Letters Patent of the United States of America and the property in the patents of the United States of America and thereas in the one of the processor of the Proceeding of Patents or securing of patents in the United States and countries foreign the relative such assigns of the whole right, title and interest the Commissioner of Patents to issue said United States of America and thereas and to any other benefits accraing or to accrue to me whole right, title and interest theretor.  And I further agree to execute all accessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its successors, assigns and legal representat	As the below	named inventor, I hereby declare that:	
The above-identified application was made or authorized to be made by me.  I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.  WHEREAS, TADANO LTD. , with offices at Ko-34, Shindencho, Takamatsu-shi, Kagawa 761-0185, JAPAN		The attached application or	
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Inventor: Shinsuke KANDA Date: August. 18. 2022			
$VV_{I}$ , $V=QV_{I}$	LEGAL NAM	ME OF INVENTOR	
$VV_{I}$ , $V=QV_{I}$	Inventor:	Shinsuke KANDA Date: August. 18. 2022	
	Signature:	Shinsuke Kanda	

**RECORDED: 08/25/2022** 

PATENT REEL: 060902 FRAME: 0692